

Conductive polymer chip capacitors (New Bottom surface electrode type: Extra Large capacitance)

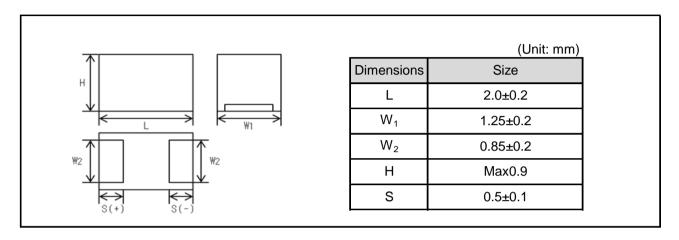
TCSO series PS case

Datasheet

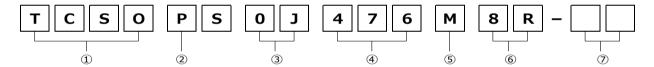
Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) New package structure results in the largest capacitance.
- 3) Compact, low profile, ultra-high capacitance contributes to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

Dimensions



Part No. Explanation



① Series name TCSO

2 Case style

PS: 2012-2012(09)size

3 Rated voltage

rtated voltage							
CODE	Rated voltage(V)						
0E	2.5						
0G	4						
0J	6.3						
0K	8						
1A	10						
1C	16						
1D	20						
1E	25						
1V	35						
1H	50						

4 Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

(5) Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

7 Discrimination code

TCSO series PS case Datasheet

Rated table

 $ESR(m\Omega)$

Capaci	tance	Rated voltage (V.DC)							
(µF	=)	4 6.3 8 10 16 2				20	25	35	
1	(105)								※ 500
1.5	(155)								
2.2	(225)								
3.3	(335)								
4.7	(475)							☆ 500	
6.8	(685)								
10	(106)								
15	(156)								
22	(226)				☆200				
33	(336)								
47	(476)		150	150					
68	(686)								
100	(107)								

☆Under development ※Rated voltage 38V

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC			
Voltage Code	Voltage (V)			
е	2.5			
g	4			
j	6.3			
k	8			
Α	10			
С	16			
D	20			
E	25			
V	35			
Н	50			

Capacitance	Nominal	Capacitance	Nominal
Code	Capacitance (µF)	Code	Capacitance (µF)
<u>E</u>	0.15	е	15
<u>N</u>	0.33	j	22
<u>S</u>	0.47	n	33
Α	1.0	S	47
E	1.5	w	68
J	2.2	а	100
N	3.3	Ф	150
S	4.7	ij	220
W	6.8	n	330
а	10	s	470

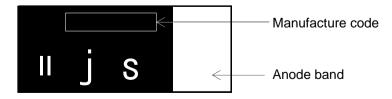
Visual typical example

voltage code and capacitance code are variable with parts number.

[TCSO series PS case]

EX.)
$$\frac{j}{(1)}$$
 $\frac{s}{(2)}$

- (1) voltage code
- (2) capacitance code



Characteristics

Item		Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)				
Operating Temp	erature	-55℃~+105℃	Voltage reduction when temperature exceeds +85°C				
Maximum operat temperature with voltage derating	-	+85℃					
Rated voltage (V	'.DC)	Refer to " Standard list ".	at 85℃				
Category voltage	e (V.DC)	Refer to " Standard list ".	at 105℃				
Surge voltage (V	'.DC)	Refer to " Standard list ".	at 85℃				
DC Leakage cur	rent	Shall be satisfied the value on "Standard list ".	As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage: Rated voltage for 5min				
Capacitance tole	erance	Shall be satisfied allowance range. ±20%	Voltage: Rated voltage for 5min As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency: 120 ± 12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC Equivalent series circuit				
Tangent of loss a (Df,tanδ)	angle	Shall be satisfied the value on "Standard list ".	As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency: 120 ± 12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC Equivalent series circuit				
ESR		Shall be satisfied the value on "Standard list ".	As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency: 100 ± 10kHz Measuring voltage: 0.5Vrms or less Measuring circuit: DC Equivalent series circuit				
Resistance to Soldering heat	Appe- arance	There should be no significant abnormality. The indications should be clear.	As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3 Dip in the solder bath				
	L.C.	Less than 300% of initial limit.	Solder temp : 240 ± 5°C Duration : 10 ± 0.5s				
	⊿C/C	Within ±20% of initial value.	Repetition: 1 After the specimens, leave it at room temperature				
	DF (tanδ)	Less than 300% of initial limit.	for over 24h and then measure the sample.				
Temperature cycle	Appe- arance	There should be no significant abnormality. The indications should be clear.	As per 4.16 JIS C 5101-1 As per 4.10 JIS C 5101-3 Repetition: 5 cycles				
	L.C.	Less than 1000% of initial limit.	(1 cycle : steps 1 to 4) without discontinuation.				
	⊿C/C	Within ±20% of initial value.	Temp. Time 1 -55±3℃ 30±3min				
	DF (tanδ)	Less than 300% of initial limit.	2 Room Temp. 3min or less 3 105±2℃ 30±3min 4 Room Temp. 3min or less				
			After the specimens, leave it at room temperature for over 24h and then measure the sample.				

Item	ı	Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)					
Moisture resistance	Appe- arance	There should be no significant abnormality. The indications should be clear.	As per 4.22 JIS C 5101-1 As per 4.12 JIS C 5101-3 After leaving the sample under such atmospheric					
	L.C.	Less than 300% of initial limit.	condition that the temperature and humidity are 40±2°C and 90 to 95% RH, respectively, for					
	⊿C/C	Within +30/-20% of initial value.	500+12/0h leave it at room temperature for over 24h and then measure the sample.					
	DF (tanδ)	Less than 300% of initial limit.						
Temperature	Temp.:-	55°C	As per 4.29 JIS C 5101-1					
Stability	⊿C/C	Within 0/-20% of initial value. Within 0/-30% of initial value.(PS0K476)	As per 4.13 JIS C 5101-3					
	DF	Shall be satisfied the value on						
	(tanδ)	" Standard list "						
	L.C.	_						
	Temp.: -	-105°C						
	⊿C/C	Within +50/0% of initial value.						
	DF	Shall be satisfied the value on						
	(tanδ)	" Standard list "						
	L.C.	Less than 1000% of initial limit.						
Surge	Appe-	There should be no significant	As per 4.26JIS C 5101-1					
voltage	arance	abnormality.	As per 4.14JIS C 5101-3					
		The indications should be clear.	Apply the specified surge voltage via the serial					
	L.C.	Less than 200% of initial limit.	resistance of $1k\Omega$ ever 5 ± 0.5 min. for 30 ± 5 s.					
		Less than 300% of initial limit.(PS0K476)	each time in the atmospheric condition of 85±2°C. Repeat this procedure 1,000 times.					
	⊿C/C	Within ±20% of initial value.	After the specimens, leave it at room temperature for over 24h and then measure the sample.					
	DF	Less than 200% of initial limit.						
	(tanδ)	Less than 300% of initial limit.(PS0K476)						
Loading at	Appe-	There should be no significant	As per 4.23 JIS C 5101-1					
High	arance	abnormality.	As per 4.15 JIS C 5101-3					
temperature	1.0	The indications should be clear.	After applying the rated voltage for 1000+72/0 h					
	L.C.	Less than 400% of initial limit.	without discontinuation via the serial resistance of 3Ω or less at a temperature of 85±2°C, leave					
	⊿C/C	Within ±20% of initial value.	the sample at room temperature / humidity for					
		Within +20/-30% of initial value.(PS0K476)	over 24h and measure the value.					
	DF	Less than 300% of initial limit.						
	(tanδ)							

Item		Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)				
Terminal	Capa-	The measured value should be	As per 4.35 JIS C 5101-1				
strength	citance	stable.	As per 4.9 JIS C 5101-3				
S	Appe-	There should be no significant	A force is applied to the terminal until it bends to				
	arance	abnormality.	1mm and by a prescribed tool maintains the				
			condition for 5s.				
			(See the figure below)				
			(Gee the lighte below)				
			F(Apply force) R230 F(Apply force) 1.0mm				
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1				
, 10000			As per 4.8 JIS C 5101-3				
			Apply force of 2N in the two directions shown in				
			the figure below for 10±1s after mounting the				
			terminal on a circuit board.				
			Apply force A circuit board				
Dimensions		Refer to "External dimensions".	Measure using a caliper of JIS B 7507 Class 2 or higher grade.				
Resistance to		The indication should be clear.	As per 4.32 JIS C 5101-1				
solvents			As per 4.18 JIS C 5101-3				
			Dip in the isopropyl alcohol for 30±5s, at room				
			temperature.				
Solderability		3/4 or more surface area of the	As per 4.15.2 JIS C 5101-1				
		solder coated terminal dipped in	As per 4.7 JIS C 5101-3				
		the soldering bath should be	Dip speed=25±2.5mm/s				
		covered with the new solder.	Pre-treatment (accelerated aging):				
			Leave the sample on the boiling distilled water				
			for 1h.				
			Solder temp. : 245±5°C				
			Duration: 3±0.5s				
			Solder: M705				
			Flux : Rosin 25% IPA 75%				
Vibration	Capa-	Measure value should not fluctuate	As per 4.17 JIS C 5101-1				
	citance	during the measurement.	Frequency: 10 to 55 to 10Hz/min.				
	Appe-	There should be no significant	Amplitude : 1.5mm				
	arance	abnormality.	Time : 2h each in X and Y directions				
	arance	abilomanty.					
			Mounting: The terminal is soldered on a print				
		•	circuit board.				

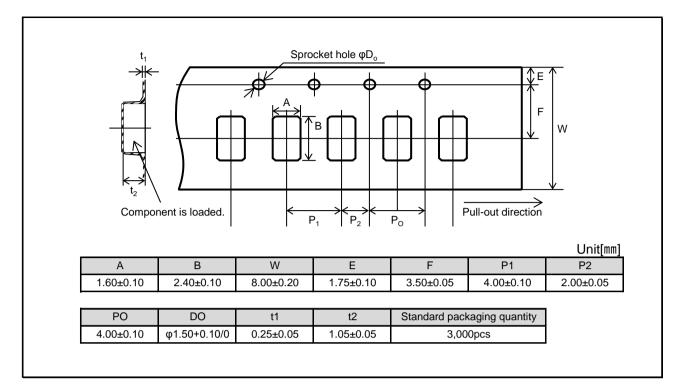


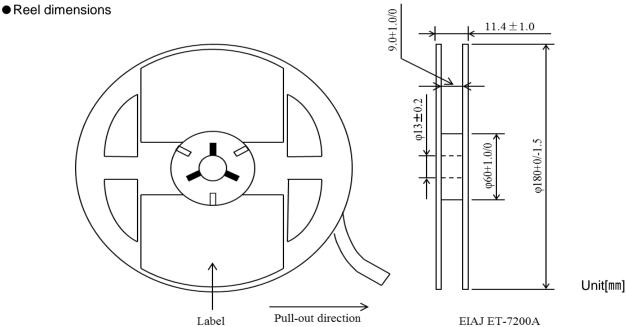
Standard products list

	Rated	Category	Surge	Cap.	Tole-	Leakage		tanδ		ESR	Max
	voltage	voltage	voltage		rance	current		120Hz			allowable
	85°C	105°C	85°C	120Hz		25℃				100kHz	ripple
Part No.						1WV	-55℃	25℃	105℃		current
						5min					≦45°C
											100kHz
	(V)	(V)	(V)	(µF)	(%)	(µA)	(%)	(%)	(%)	(mΩ)	(mArms)
TCSOPS0J476M8R-ZF1	6.3	5	8	47	±20	29.7	15	15	20	150	516
TCSOPS0K476M8R-ZF1	8	6.3	10	47	±20	37.6	15	15	20	150	516
* TCSOPS1A226M8R-ZD1	10	8	13	22	±20	22.0	15	15	20	200	447
* TCSOPS1E475M8R-ZT1	25	20	32	4.7	±20	11.8	10	10	15	500	300
TCSOPS1V105M8R-UT1	38	27	43	1	±20	11.4	10	10	15	500	280

^{*} This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

Packaging specifications



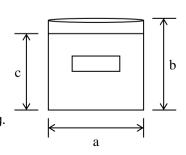


- Damp proof package
 - ①One reel is packed in aluminum bag.

The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- 3The aluminum bag is heat-sealed.
- (4) The label of the same as the label on the reel is placed on the aluminum bag.



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSIII

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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